



3CT12B

主要参数 MAIN CHARACTERISTICS

I _{T(RMS)}	16A
V _{DRM/V_{RRM}}	800V
I _{GT}	1-25mA

用途

- 半交流开关
- 相位控制

APPLICATIONS

- Half AC switching
- Phase control

产品特性

- 玻璃钝化芯片，高可靠性和一致性
- 低通态电流和高浪涌电流能力
- 环保 RoHS 产品

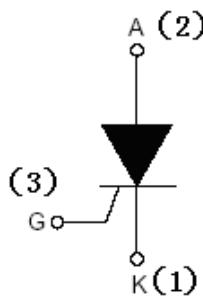
FEATURES

- Glass-passivated mesa chip for reliability and uniform
- Low on-state voltage and High I_{TSM}
- RoHS products

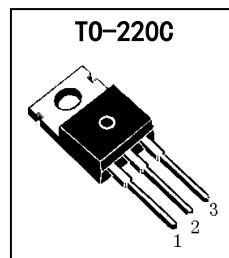
订货信息 ORDER MESSAGES

订货型号 Order codes				印记 Marking	封装 Package		
有卤-袋装	无卤-袋装	有卤-条管	无卤-条管	3CT12B	TO-220C		
Halogen-Bag	Halogen-Free-Bag	Halogen-Tube	Halogen-Free-Tube				
3CT12B-CA-C	3CT12B-CA-CR	3CT12B-CA-B	3CT12B-CA-BR				
Device summary							
Parameter	3CT12B	unit					
V _{DRM/V_{RRM}}	800	V					

封装 Package



序号 Pin	引线名称 Description
1	阴极 K
2	阳极 A
3	门极 G





3CT12B

绝对最大额定值 ABSOLUTE RATINGS (limit values)

符 号 Symbol	项 目 Parameter		数 值 Value	单 位 Unit
$I_{T\text{ (RMS)}}$	通态方均根电流 RMS on-state current(180° Conduction angle)	$T_c = 110^{\circ}\text{C}$	16	A
$I_{T\text{ (AV)}}$	通态平均电流 Average on-state current(180° Conduction angle)	$T_c = 110^{\circ}\text{C}$	10	A
$I_{T\text{SM}}$	非重复浪涌峰值通态电流 Non-repetitive surge peak on-state current	$T_p = 8.3\text{ms}$	200	A
		$T_p = 10\text{ms}$	190	
I^2t	I^2t 使用数值 I^2t Value for using	$t = 10\text{ms}$	$T_c = 25^{\circ}\text{C}$	A^2s
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}, t_r \leq 100\text{ns}$	$F = 60\text{Hz}$	$T_c = 125^{\circ}\text{C}$	$\text{A}/\mu\text{s}$
I_{GM}	峰值门极电流 Peak gate current	$T_p = 20\mu\text{s}$	$T_c = 125^{\circ}\text{C}$	5
$P_{G\text{(AV)}}$	平均门极功率 Average gate power		$T_c = 125^{\circ}\text{C}$	1
T_{stg} T_j	存储温度 Storage junction temperature range 操作结温 Operation junction temperature range		-40 to +150	$^{\circ}\text{C}$
			-40 to +125	
V_{RGM}	Maximum peak reverse gate voltage		5	V





3CT12B

电特性 ELECTRICAL CHARACTERISTIC ($T_c=25^\circ\text{C}$)

Symbol	Test Conductions		Value	Unit
I_{GT}	$V_D=12V, RL=33\Omega$		1	mA
			25	mA
V_{GT}			1.3	V
V_{GD}	$V_D=V_{DRM}, RL=3.3K\Omega$	$T_j=125^\circ\text{C}$	0.2	V
I_H	维持电流 Holding current		40	mA
I_L	擎住电流 Holding current		60	mA
dV/dt	$V_{DM}=67\% V_{DRM}$ gate open	$T_j=125^\circ\text{C}$	MAX: 1000	V/ μ s
V_{TM}	$I_{TM}=32A T_p=380\mu\text{s}$	$T_j=25^\circ\text{C}$	1.6	V
V_{IO}	Threshold voltage	$T_j=125^\circ\text{C}$	0.77	V
R_d	Dynamic resistance	$T_j=125^\circ\text{C}$	23	$\text{m}\Omega$
I_{DRM} I_{RRM}	$V_{DRM} = V_{RRM}$	$T_j=25^\circ\text{C}$	5	μA
		$T_j=125^\circ\text{C}$	2	mA
Symbol	Parameter		value	Unit
$R_{th(j-c)}$	junction to case (DC)		1.1	$^\circ\text{C}/\text{W}$
$R_{th(j-a)}$	junction to ambient (DC)		60	$^\circ\text{C}/\text{W}$

Figure 1. Maximum average power dissipation versus average on-state current

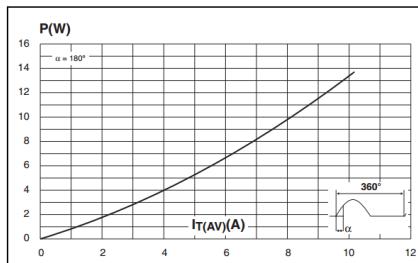


Figure 2. Average and D.C. on-state current versus case temperature

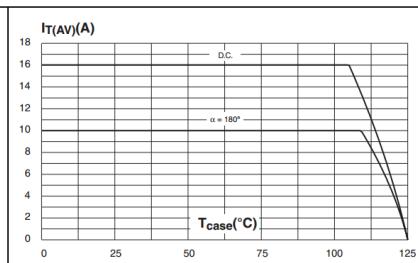


Figure 3. Average and D.C. on-state current versus ambient temperature (copper surface under tab: $S=1\text{cm}^2$) (D²PAK)

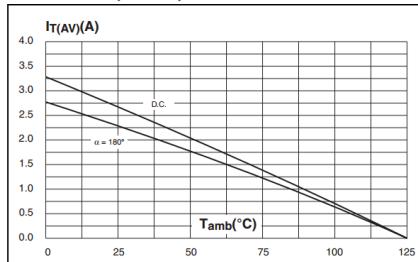


Figure 4. Relative variation of thermal impedance versus pulse duration

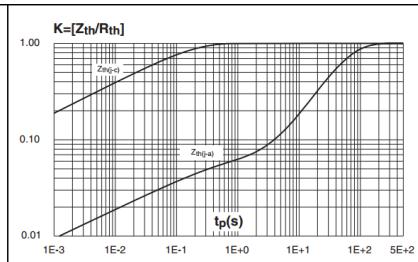


Figure 5. Relative variation of gate trigger current, holding current and latching current versus junction temperature

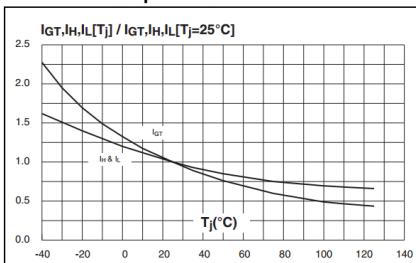


Figure 6. Surge peak on-state current versus number of cycles

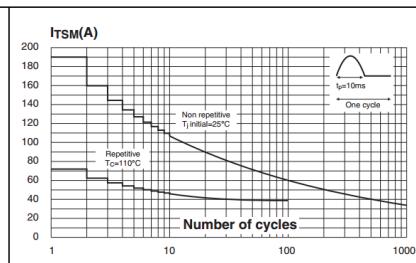


Figure 7. Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10$ ms, and corresponding values of I^2t

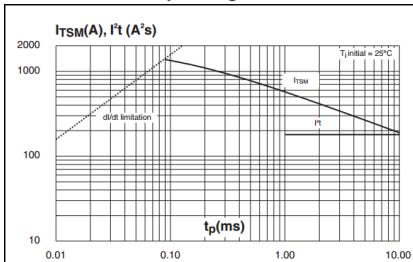


Figure 8. On-state characteristics (maximum values)

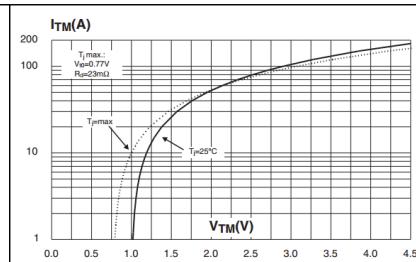
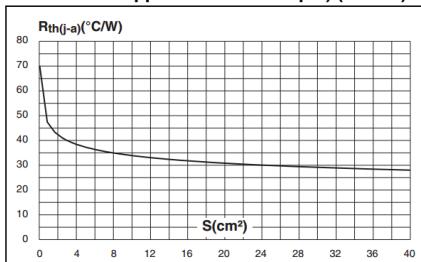


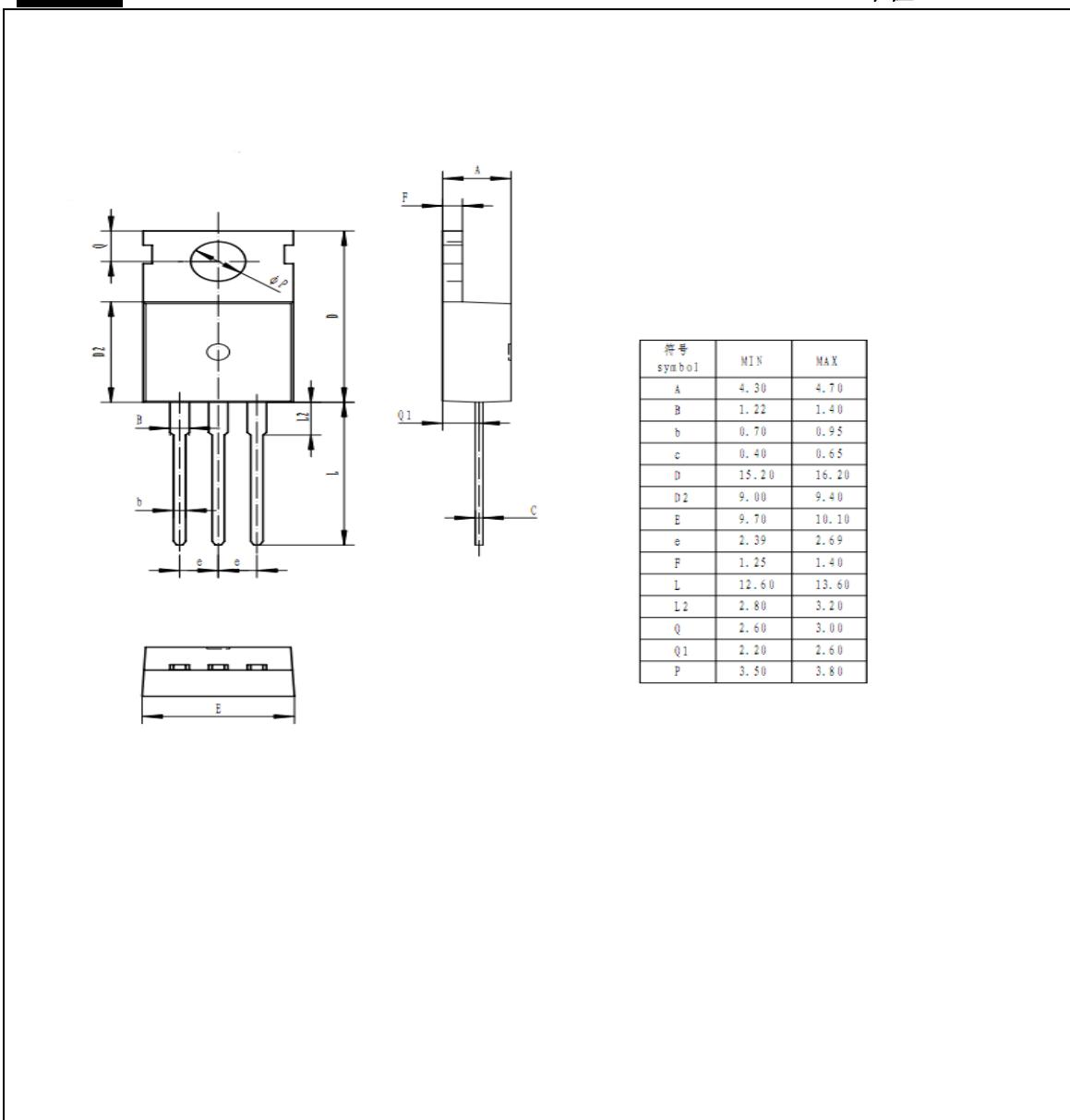
Figure 9. Thermal resistance junction to ambient versus copper surface under tab
(epoxy printed circuit board FR4, copper thickness: 35 μm) (D²PAK)



外形尺寸 PACKAGE MECHANICAL DATA

TO-220C

单位 Unit : mm



单位 Unit : mm



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